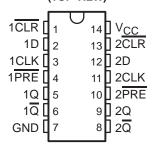
- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Typical V_{OLP} (Output Ground Bounce)
 < 0.8 V at V_{CC}, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 > 2 V at V_{CC}, T_A = 25°C
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Package Options Include Plastic Small-Outline (D, NS), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages, Ceramic Flat (W) Packages, Chip Carriers (FK), and DIPs (J)

description

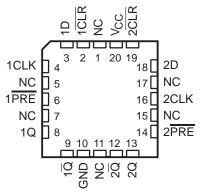
These dual positive-edge-triggered D-type flip-flops are designed for 2-V to 5.5-V $\rm V_{CC}$ operation.

A low level at the preset (PRE) or clear (CLR) inputs sets or resets the outputs, regardless of the levels of the other inputs. When PRE and CLR are inactive (high), data at the data (D) inputs meeting the setup-time requirements is transferred to the outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a voltage level and is not directly related to the rise time of the clock pulse. Following the hold-time interval, data at the D input can be changed without affecting the levels at the outputs.

SN54LV74A . . . J OR W PACKAGE SN74LV74A . . . D, DB, DGV, NS, OR PW PACKAGE (TOP VIEW)



SN54LV74A . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54LV74A is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74LV74A is characterized for operation from –40°C to 85°C.



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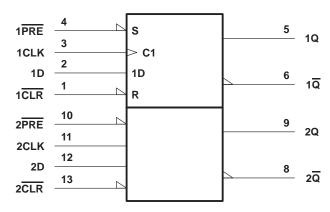


FUNCTION TABLE

| | INP | UTS | | OUTI | PUTS |
|-----|-----|------------|---|----------------|------------------|
| PRE | CLR | CLK | D | Q | Ø |
| L | Н | Х | Χ | Н | L |
| Н | L | X | Χ | L | Н |
| L | L | X | Χ | н† | H [†] |
| Н | Н | \uparrow | Н | Н | L |
| Н | Н | \uparrow | L | L | Н |
| Н | Н | L | Χ | Q ₀ | \overline{Q}_0 |

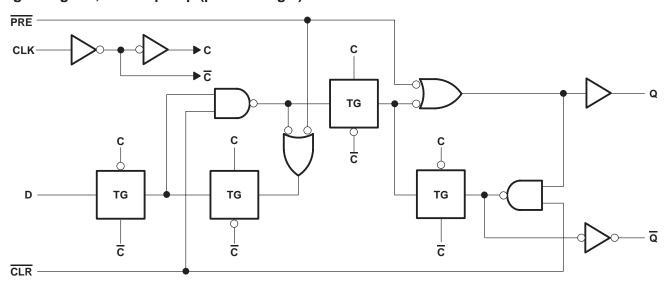
[†]This configuration is unstable; that is, it does not persist when PRE or CLR returns to its inactive (high) level.

logic symbol‡



[‡] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

logic diagram, each flip-flop (positive logic)





absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | | –0.5 V to 7 V |
|--|-------------|--|
| Input voltage range, V _I (see Note 1) | | –0.5 V to 7 V |
| Output voltage range, VO (see Notes 1 and 2) | | $10.5 \text{ V to V}_{CC} + 0.5 \text{ V}$ |
| Input clamp current, I_{IK} ($V_I < 0$) | | –20 mA |
| Output clamp current, IOK (VO < 0 or VO > VCO | c) | ±50 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | - | ±25 mA |
| Continuous current through V _{CC} or GND | | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 3): | D package | 127°C/W |
| • | DB package | 158°C/W |
| | DGV package | 182°C/W |
| | NS package | 127°C/W |
| | PW package | 170°C/W |
| Storage temperature range, T _{Stg} | | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

- 2. This value is limited to 7 V maximum.
- 3. The package thermal impedance is calculated in accordance with JESD 51.

recommended operating conditions (see Note 4)

| | | | SN54I | _V74A | SN74L | .V74A | UNIT |
|---------------------|------------------------------------|--|-----------------------|----------------------|-----------------------|----------------------|------|
| | | | MIN | MAX | MIN | MAX | UNII |
| Vcc | Supply voltage | | 2 | 5.5 | 2 | 5.5 | V |
| | | V _{CC} = 2 V | 1.5 | | 1.5 | | |
| \ <i>/.</i> | High lavel input valtage | V _{CC} = 2.3 V to 2.7 V | V _{CC} ×0.7 | | V _{CC} × 0.7 | | V |
| VIH | High-level input voltage | V _{CC} = 3 V to 3.6 V | V _{CC} × 0.7 | | V _{CC} × 0.7 | | ľ |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | V _{CC} × 0.7 | | V _{CC} × 0.7 | | |
| | | V _{CC} = 2 V | | 0.5 | | 0.5 | |
| \/ | Low-level input voltage | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | $V_{CC} \times 0.3$ | | $V_{CC} \times 0.3$ | V |
| V_{IL} | Low-level input voltage | V _{CC} = 3 V to 3.6 V | | VCC×0.3 | | $V_{CC} \times 0.3$ | ľ |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | V _{CC} ×0.3 | | V _{CC} ×0.3 | |
| ٧ı | Input voltage | | 0 | 5.5 | 0 | 5.5 | V |
| ٧o | Output voltage | | 0 | Vcc | 0 | Vcc | V |
| | | V _{CC} = 2 V | | S –50 | | -50 | μΑ |
| lou | High lavel output ourrent | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 90 | -2 | | -2 | |
| ЮН | High-level output current | V _{CC} = 3 V to 3.6 V | Q | -6 | | -6 | mA |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | -12 | | -12 | |
| | | V _{CC} = 2 V | | 50 | | 50 | μΑ |
| lo | Low-level output current | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 2 | | 2 | |
| lOL | Low-level output current | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$ | | 6 | | 6 | mA |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 12 | | 12 | |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 0 | 200 | 0 | 200 | |
| $\Delta t/\Delta v$ | Input transition rise or fall rate | $V_{CC} = 3 \text{ V to } 3.6 \text{ V}$ | 0 | 100 | 0 | 100 | ns/V |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 0 | 20 | 0 | 20 | |
| TA | Operating free-air temperature | | -55 | 125 | -40 | 85 | °C |

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | l | SN54LV74A | SN74LV74A | UNIT |
|------------------|---|--------------|----------------------|----------------------|------|
| PARAMETER | TEST CONDITIONS | VCC | MIN TYP MAX | MIN TYP MAX | UNII |
| | I _{OH} = -50 μA | 2 V to 5.5 V | V _{CC} -0.1 | V _{CC} -0.1 | |
| Vari | I _{OH} = -2 mA | 2.3 V | 2 | 2 | V |
| VOH | I _{OH} = -6 mA | 3 V | 2.48 | 2.48 | ٧ |
| | I _{OH} = -12 mA | 4.5 V | 3.8 | 3.8 | |
| | I _{OL} = 50 μA | 2 V to 5.5 V | 0.1 | 0.1 | |
| Va | I _{OL} = 2 mA | 2.3 V | 0.4 | 0.4 | V |
| V _{OL} | I _{OL} = 6 mA | 3 V | 0.44 | 0.44 | V |
| | I _{OL} = 12 mA | 4.5 V | 0.55 | 0.55 | |
| Ц | $V_I = V_{CC}$ or GND | 5.5 V | ±1 | ±1 | μΑ |
| ICC | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | 20 | 20 | μΑ |
| l _{off} | V _I or V _O = 0 to 5.5 V | 0 V | 5 | 5 | μΑ |
| C. | V _I = V _{CC} or GND | 3.3 V | 2.1 | 2.1 | pF |
| C _i | AL = ACC OL GIAD | 5 V | 2.1 | 2.1 | ÞΓ |

timing requirements over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

| | PARAMETER | | T _A = 2 | 25°C | SN54L | .V74A | SN74L | V74A | UNIT |
|-----------------|----------------------------|---------------------|--------------------|------|-------|-------|-------|------|------|
| | PARAMETER | _ | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Pulse duration | PRE or CLR low | 8 | | 9 | | 9 | | no |
| t _W | Pulse duration | CLK | 8 | | 9 | W.U | 9 | | ns |
| Γ. | Cotum times hafers CLIV | Data | 8 | | 9 | 111 | 9 | | no |
| t _{su} | Setup time before CLK↑ | PRE or CLR inactive | 7 | | 7 | · | 7 | | ns |
| t _h | Hold time, data after CLK↑ | | 0.5 | | 0.5 | | 0.5 | | ns |

timing requirements over recommended operating free-air temperature range, V $_{CC}$ = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

| | PARAMETER | | $T_A = 2$ | 25°C | SN54L | .V74A | SN74L | V74A | UNIT |
|-----------------|----------------------------|---------------------|-----------|------|-------|-------|-------|------|------|
| | FARAMETER | | MIN | MAX | MIN | MAX | MIN | MAX | ONIT |
| | Pulse duration | PRE or CLR low | 6 | | 7 | > | 7 | | ns |
| t _W | ruise duration | CLK | 6 | | 7 | N.C. | 7 | | 115 |
| | Cation times hadans CLVA | Data | 6 | | 7 | JIV. | 7 | | no |
| t _{su} | Setup time before CLK↑ | PRE or CLR inactive | 5 | | 5 | | 5 | | ns |
| t _h | Hold time, data after CLK↑ | | 0.5 | | 0.5 | | 0.5 | | ns |

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| | PARAMETER | | T _A = : | 25°C | SN54L | .V74A | SN74L | .V74A | UNIT |
|-----------------|-----------------------------|---------------------|--------------------|------|-------|-------|-------|-------|------|
| | FARAIMETER | | MIN | MAX | MIN | MAX | MIN | MAX | UNIT |
| | Pulse duration | PRE or CLR low | 5 | | 5 | | 5 | | no |
| t _W | ruise duration | CLK | 5 | | 5 | 10,74 | 5 | | ns |
| | Catura time a hafarra CLIVA | Data | 5 | | 5 | M | 5 | | no |
| t _{su} | Setup time before CLK↑ | PRE or CLR inactive | 3 | | 3 | | 3 | | ns |
| th | Hold time, data after CLK↑ | | 0.5 | | 0.5 | | 0.5 | | ns |

switching characteristics over recommended operating free-air temperature range, V_{CC} = 2.5 V \pm 0.2 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM | то | LOAD | T, | Վ = 25° C | ; | SN54L | V74A | SN74L | .V74A | UNIT |
|------------------|------------|------------------------------|-------------------------|-----|------------------|------|----------------|------|-------|-------|--------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| | | | C _L = 15 pF* | 50 | 100 | | 40 | 1/5/ | 40 | | MHz |
| fmax | | | C _L = 50 pF | 30 | 70 | | 25 | ?E1 | 25 | | IVITIZ |
| 4 .* | PRE or CLR | 0 0 | C _I = 15 pF | | 9.8 | 14.8 | 1,5 | 17 | 1 | 17 | ns |
| ^t pd* | CLK | Q or Q | CL = 15 pr | | 11.1 | 16.4 | 3 | 19 | 1 | 19 | 115 |
| | PRE or CLR | Q or $\overline{\mathbb{Q}}$ | C 50 pF | | 13 | 17.4 | Q ₁ | 20 | 1 | 20 | no |
| ^t pd | CLK | Q OF Q | C _L = 50 pF | | 14.2 | 20 | Q 1 | 23 | 1 | 23 | ns |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM | то | LOAD | T, | ղ = 25°C | ; | SN54L | .V74A | SN74L | .V74A | UNIT |
|-------------------|------------|------------------------------|-------------------------|-----|----------|------|----------------|-------|-------|-------|--------|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNIT |
| , | | | C _L = 15 pF* | 80 | 140 | | 70 | 1/5 | 70 | | MHz |
| fmax | | | C _L = 50 pF | 50 | 90 | | 45 | 7.E. | 45 | | IVITIZ |
| 4 .* | PRE or CLR | 0 | C _I = 15 pF | | 6.9 | 12.3 | 1,4 | 14.5 | 1 | 14.5 | no |
| t _{pd} * | CLK | Q or Q | CL = 15 pr | | 7.9 | 11.9 | ₩, | 14 | 1 | 14 | ns |
| 4 . | PRE or CLR | Q or $\overline{\mathbb{Q}}$ | C _I = 50 pF | | 9.2 | 15.8 | Q ₁ | 18 | 1 | 18 | no |
| ^t pd | CLK | QUIQ | CL = 50 pr | | 10.2 | 15.4 | Q 1 | 17.5 | 1 | 17.5 | ns |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

| •• | - | | | _ | - | | | | | | |
|------------------|------------|------------------------------|-------------------------|-----|---------------------|-----|-------|-------|-------|-------|--------|
| PARAMETER | FROM | то | LOAD | T, | _λ = 25°C | ; | SN54L | .V74A | SN74L | .V74A | UNIT |
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | MIN | MAX | UNII |
| | | | C _L = 15 pF* | 130 | 180 | | 110 | 1/5 | 110 | | MHz |
| fmax | | | C _L = 50 pF | 90 | 140 | | 75 | 751 | 75 | | IVITIZ |
| 4 .* | PRE or CLR | 0 | C _I = 15 pF | | 5 | 7.7 | 1, | 9 | 1 | 9 | 20 |
| ^t pd* | CLK | Q or Q | C[= 15 pr | | 5.6 | 7.3 | 3 | 8.5 | 1 | 8.5 | ns |
| | PRE or CLR | Q or $\overline{\mathbb{Q}}$ | C _I = 50 pF | | 6.6 | 9.7 | 81 | 11 | 1 | 11 | ne |
| ^t pd | CLK | QUIQ | CL = 50 pr | | 7.2 | 9.3 | 2 1 | 10.5 | 1 | 10.5 | ns |

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



SN54LV74A, SN74LV74A DUAL POSITIVE-EDGE-TRIGGERED D-TYPE FLIP-FLOPS

SCLS381D – AUGUST 1997 – REVISED JUNE 1998

noise characteristics, V_{CC} = 3.3 V, C_L = 50 pF, T_A = 25°C (see Note 5)

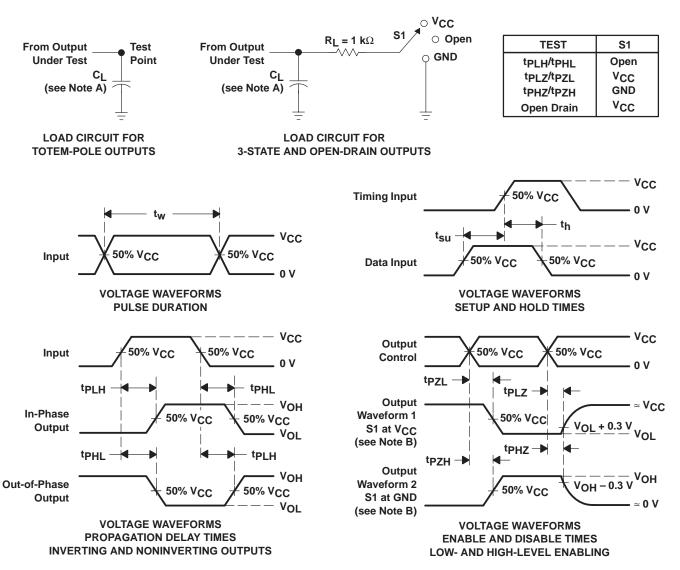
| | PARAMETER | SN | 74LV74 | A | UNIT |
|--------------------|---|------|--------|------|------|
| | PARAMETER | MIN | TYP | MAX | UNIT |
| V _{OL(P)} | Quiet output, maximum dynamic V _{OL} | | 0.1 | 0.8 | V |
| V _{OL(V)} | Quiet output, minimum dynamic V _{OL} | | -0.04 | -0.8 | V |
| VOH(V) | Quiet output, minimum dynamic VOH | | 3.2 | | V |
| VIH(D) | High-level dynamic input voltage | 2.31 | | | V |
| V _{IL(D)} | Low-level dynamic input voltage | | | 0.99 | V |

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^{\circ}C$

| | PARAMETER | TEST CO | NDITIONS | VCC | TYP | UNIT |
|-----|--------------------------------|---------------|---------------|-------|-----|------|
| C . | Power dissipation capacitance | $C_1 = 50 pF$ | f = 10 MHz | 3.3 V | 21 | ρF |
| Cbq | i owei dissipation capacitance | CL = 50 pr, | 1 – 10 101112 | 5 V | 23 | þr |

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns, $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. t_{PHL} and t_{PLH} are the same as t_{pd} .

Figure 1. Load Circuit and Voltage Waveforms

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